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STD12NF06L-1 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	60	V
V _{GS}	Gate-source voltage	± 16	V
I _D	Drain current (continuous) at T _C = 25 °C	12	Α
I _D	Drain current (continuous) at T _C = 100 °C	8.5	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	48	Α
P _{TOT}	Total dissipation at T _C = 25 °C	30	W
	Derating factor	0.2	W/°C
dv/dt ⁽²⁾	Peak diode recovery voltage slope	15	V/ns
E _{AS} ⁽³⁾	Single pulse avalanche energy	100	mJ
T _{stg}	Storage temperature	55 to 175	°C
TJ	Max. operating junction temperature	-55 to 175	

^{1.} Pulse width limited by safe operating area

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max.	5	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max.	100	°C/W

 $^{2. \}quad I_{SD} \leq 12 \ A, \ di/dt \leq 200 \ A/\mu s, \ V_{DS} \leq 40 \ V, \ T_J \leq T_{JMAX}$

^{3.} Starting $T_J = 25$ °C, $I_D = 6$ A, $V_{DD} = 30$ V

Electrical characteristics STD12NF06L-1

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0$, $I_D = 250 \mu A$,	60			V
	Zoro goto voltago drain	$V_{GS} = 0, V_{DS} = 60$			1	μΑ
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0, V_{DS} = 60$ $T_{C} = 125 ^{\circ}C$			10	μA
I _{GSS}	Gate body leakage current	$V_{DS} = 0$ $V_{GS} = \pm 16 \text{ V}$			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1		2	V
R _{DS(on)}	Static drain-source	$V_{GS} = 10 \text{ V}, I_D = 6 \text{ A}$		0.07	0.09	Ω
	on-resistance	$V_{GS} = 5 \text{ V}, I_D = 6 \text{ A}$		0.08	0.10	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance			350		pF
C _{oss}	Output capacitance	$V_{DS} = 25 \text{ V, f} = 1 \text{ MHz,}$		75		pF
C _{rss}	Reverse transfer capacitance	V _{GS} = 0		30		pF
Q_g	Total gate charge	V _{DD} = 48 V, I _D = 12 A		7.5	10	nC
Q _{gs}	Gate-source charge	V _{GS} = 5 V		2.5		nC
Q_{gd}	Gate-drain charge	(see Figure 14)		3.0		nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time			10		ns
t _r	Rise time	$V_{DD} = 30 \text{ V}, I_{D} = 6 \text{ A},$ $R_{G} = 4.7 \Omega, V_{GS} = 4.5 \text{ V}$		35		ns
t _{d(off)}	Turn-off delay time	$R_G = 4.7 \Omega$, $V_{GS} = 4.3 V$ (see Figure 13)		20		ns
t _f	Fall time	,		13		ns



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Table 7. Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current				12	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				48	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 12 A, V _{GS} = 0			1.5	٧
t _{rr}	Reverse recovery time	I _{SD} = 12 A,		50		ns
Q _{rr}	Reverse recovery charge	di/dt = 100 A/μs, V _{DD} = 16 V, T _{.I} = 150 °C		65		nC
I _{RRM}	Reverse recovery current	(see <i>Figure 15</i>)		2.5		Α

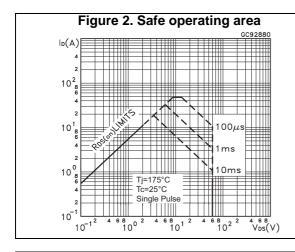
^{1.} Pulse width limited by safe operating area.

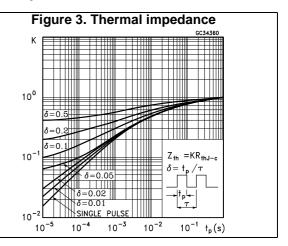


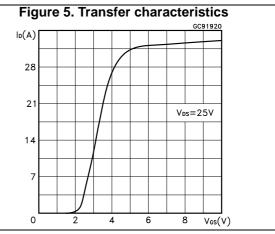
^{2.} Pulsed: pulse duration = 300 μ s, duty cycle 1.5%.

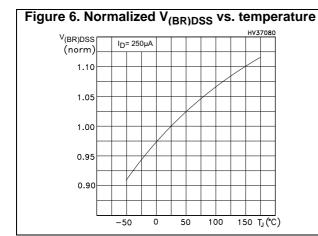
Electrical characteristics STD12NF06L-1

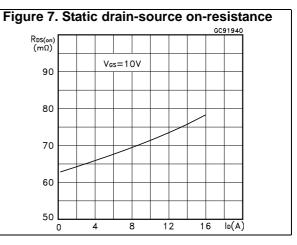
2.1 Electrical characteristics (curves)











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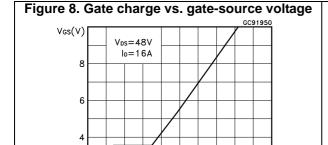


Figure 10. Normalized gate threshold voltage vs. temperature

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12

Q_g(nC)

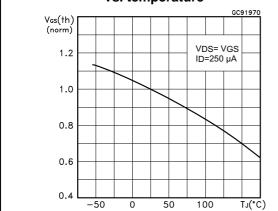


Figure 11. Normalized on-resistance vs. temperature

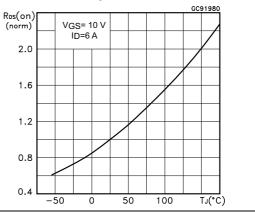


Figure 12. Source-drain diode forward characteristics

Vsb(V)

1.2

TJ=-40°C

25°C

175°C

0.8

0.6

0.4

0.4

8

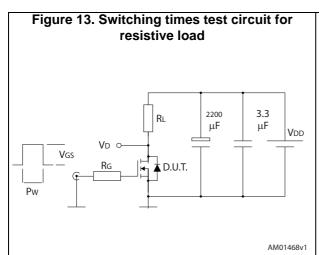
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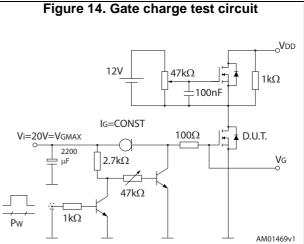
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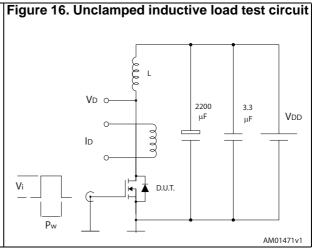
Isb(A)

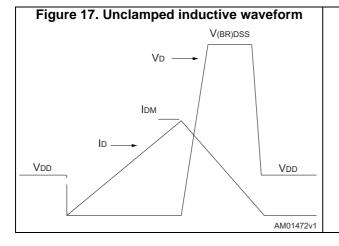
Test circuit STD12NF06L-1

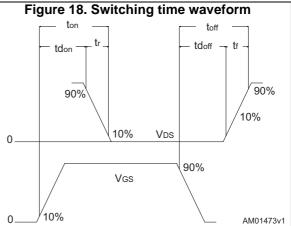
3 Test circuit











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4 Package mechanical data

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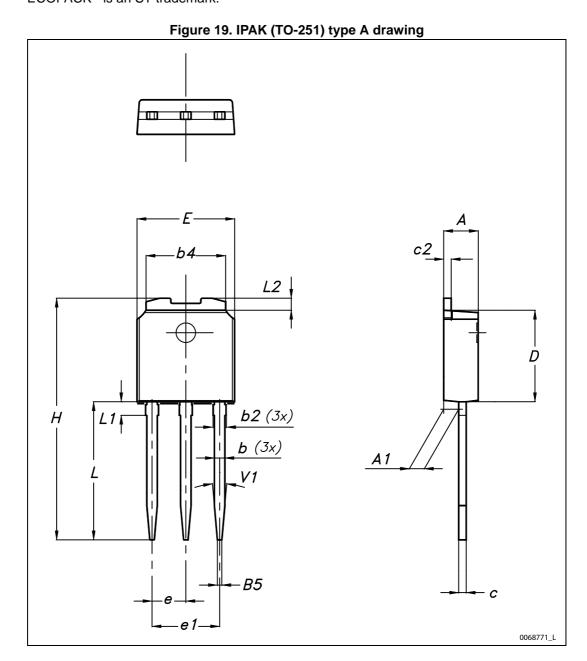


Table 8. IPAK (TO-251) type A mechanical data

DIM		mm.	
DIM	min.	typ.	max.
А	2.20		2.40
A1	0.90		1.10
b	0.64		0.90
b2			0.95
b4	5.20		5.40
B5		0.30	
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
E	6.40		6.60
е		2.28	
e1	4.40		4.60
Н		16.10	
L	9.00		9.40
L1	0.80		1.20
L2		0.80	1.00
V1		10°	

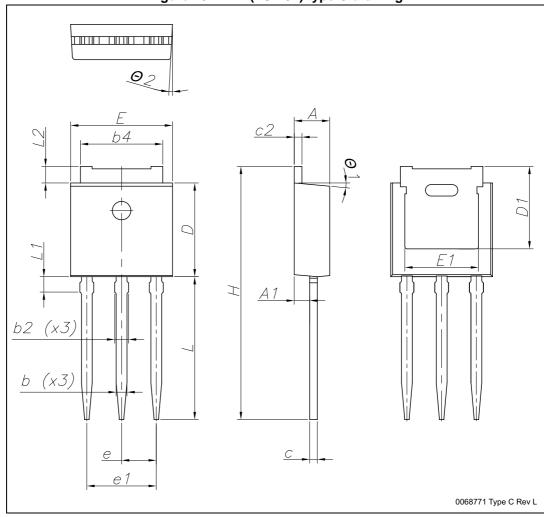


Figure 20. IPAK (TO-251) type C drawing

Table 9. IPAK (TO-251) type C mechanical data

Dim.		mm	
Dim.	min.	typ.	max.
А	2.20	2.30	2.35
A1	0.90	1.00	1.10
b	0.66		0.79
b2			0.90
b4	5.23	5.33	5.43
С	0.46		0.59
c2	0.46		0.59
D	6.00	6.10	6.20
D1	5.20	5.37	5.55
E	6.50	6.60	6.70
E1	4.60	4.78	4.95
е	2.20	2.25	2.30
e1	4.40	4.50	4.60
Н	16.18	16.48	16.78
L	9.00	9.30	9.60
L1	0.80	1.00	1.20
L2	0.90	1.08	1.25
θ1	3°	5°	7°
θ2	1°	3°	5°

STD12NF06L-1 Revision history

5 Revision history

Table 10. Document revision history

Date Revision		Changes		
03-Jul-2014 1		Initial release.The part number STD12NF06L-1 previously included in datasheet with docID8179.		
15-Oct-2014	2 Updated Section 4: Package mechanical data.			
14-Nov-2014	3	Updated title in cover page and <i>Table 4: On/off states</i> . Updated <i>Figure 2: Safe operating area</i> , <i>Figure 3: Thermal impedance</i> , <i>Figure 10: Normalized gate threshold voltage vs. temperature</i> and <i>Figure 11: Normalized on-resistance vs. temperature</i> . Minor text changes.		

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